# Section VI: Displacement Damage and Special Issues for Optoelectronics

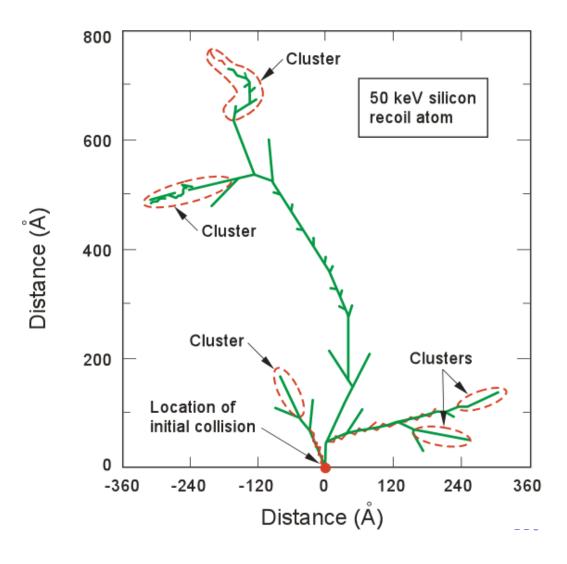
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Section 514

## Displacement Damage for High Energy Transfer

#### **Displacement Cascade**

Several damage clusters are produced by the collision

Damage is caused by movement of lattice atom after primary collision



## Displacement Damage

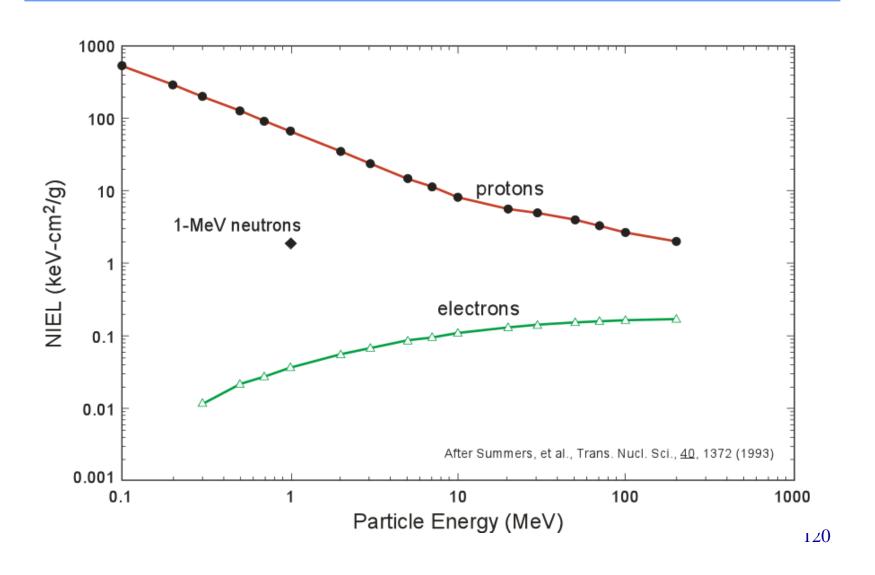
#### Effects of Displacement Damage in Semiconductors

- Minority carrier lifetime is degraded
  - Reduces gain of bipolar transistors
  - Also affects optical detectors and some types of light-emitting diodes
  - Effects become important for proton fluences above 1 x 10<sup>10</sup> p/cm<sup>2</sup>
- Mobility and carrier concentration are also affected

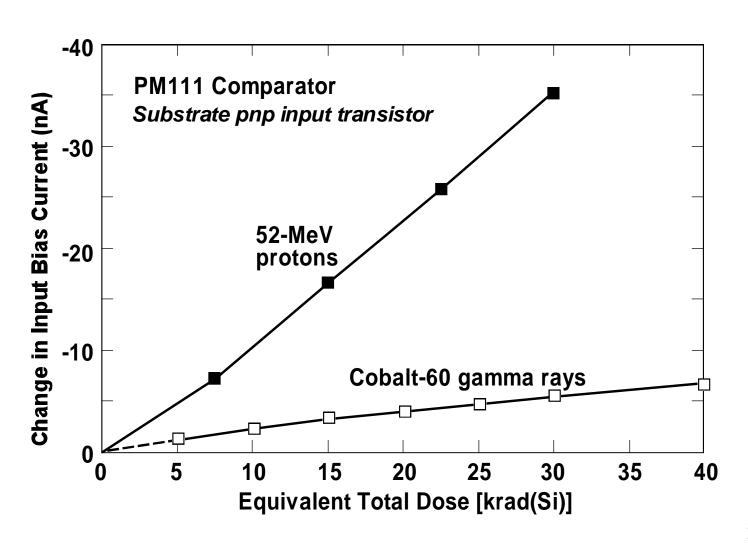
#### Particles Producing Displacement Damage

- Protons (all energies)
- Electrons with energies above 150 keV
- Neutrons (from on-board power sources)

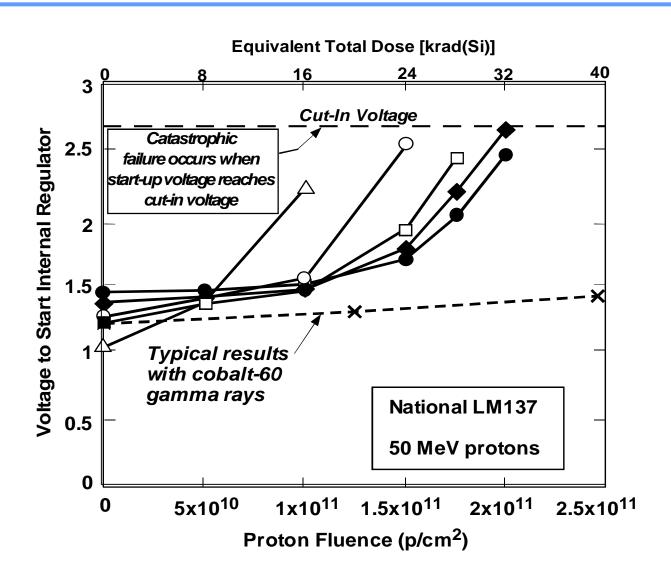
## Energy Dependence of Displacement Damage in Silicon



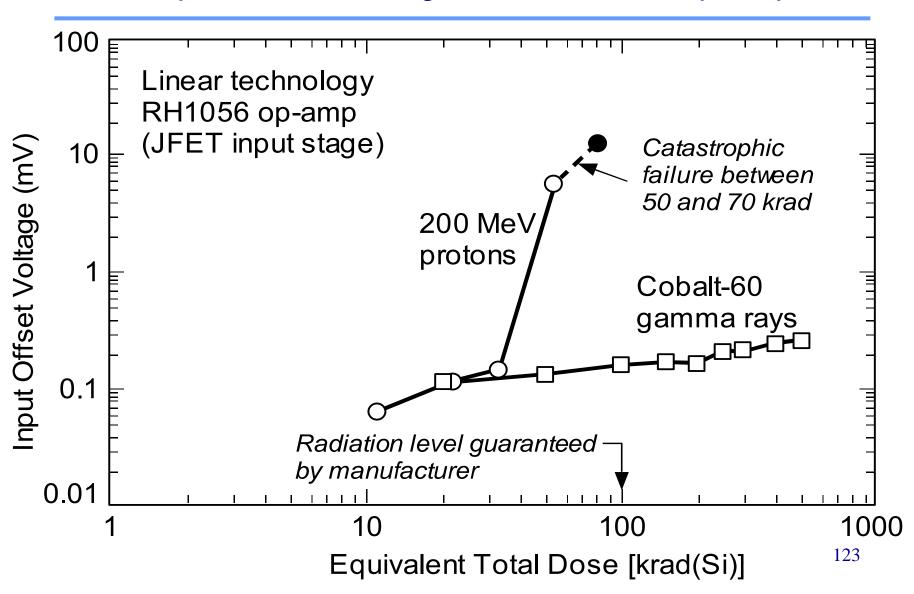
# Effects of Gamma and Proton Irradiation on Input Bias Current of a Differential Comparator



## Displacement Damage in a Voltage Regulator



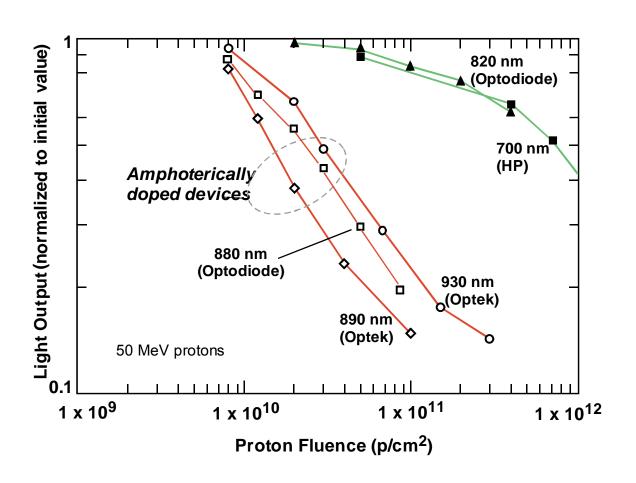
## Displacement Damage in a Hardened Op-Amp



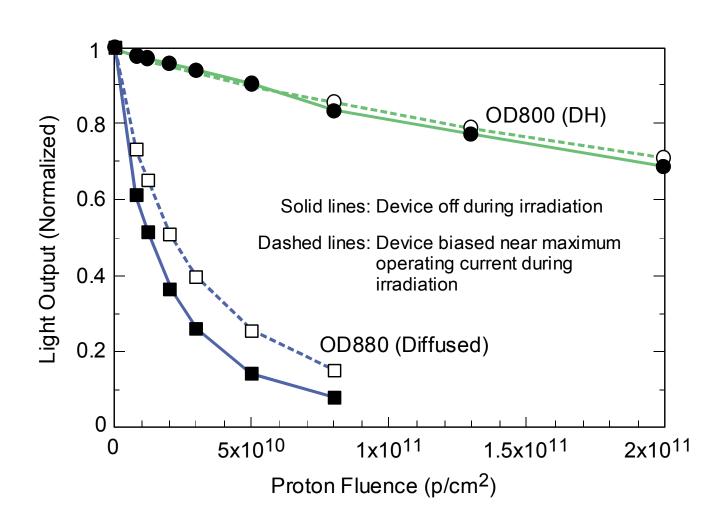
## **Displacement Damage Comparisons**

Particle Type	Total Dose [rad(Si)]	Fluence (#/cm <sup>2</sup> )	Equiv. Neutron Fluence (n/cm <sup>2</sup> )
electrons (100 MeV)	100k	$3.3 \times 10^{12}$	$3.8 \times 10^{11}$
electrons (2 MeV)	100k	4.1 x 10 <sup>12</sup>	8.6 x 10 <sup>10</sup>
protons (50 MeV)	100k	6.2 x 10 <sup>11</sup>	$1.4 \times 10^{12}$

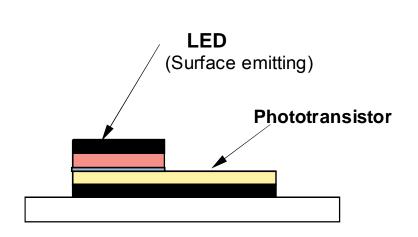
## **Degradation of Light-Emitting Diodes**

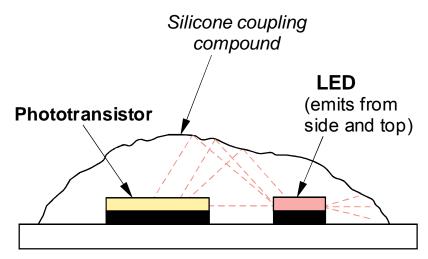


## Comparison of Two LED Technologies



## **Optocoupler Construction**

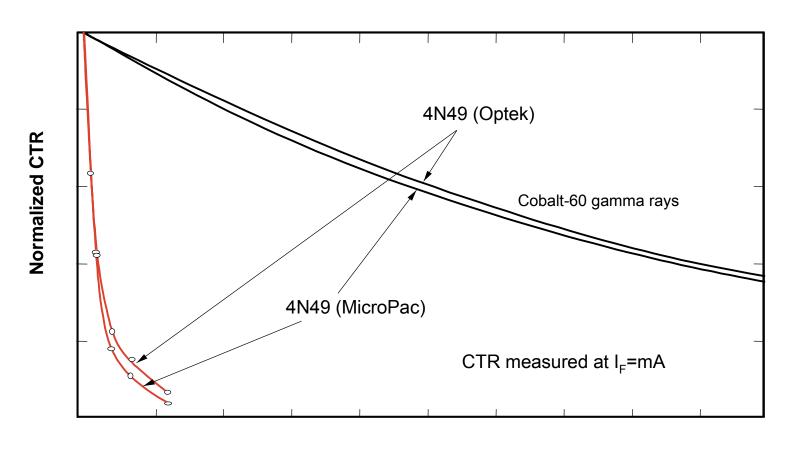




(a) Sandwich structure (direct coupling to detector)

(b) Lateral structure (reduced coupling efficiency)

## **Optocoupler Degradation**



Total Dose [krad (Si)]

## Failure of Optocouplers on Topex-Poseidon

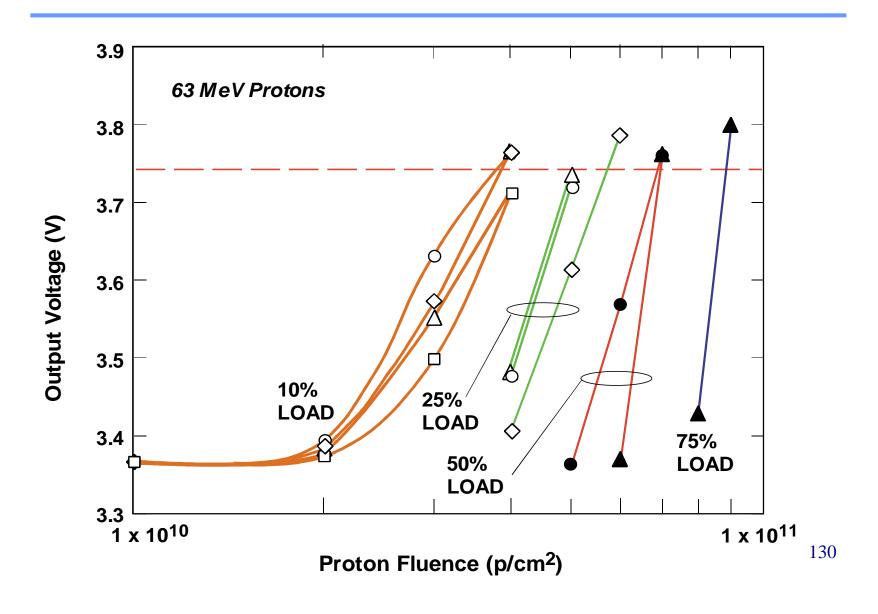
#### **High-Inclination Earth Orbit**

- 1300 km, 98 degrees
- Goes through lower edge of proton radiation belts

#### Optocouplers Used in Five Different Circuit Applications

- Failure occurred in thruster status application after 2.7 years
  - Design did not consider displacement damage
  - Circuit failure corresponds to a factor of four reduction in currenttransfer ratio
  - Cold "spares" of little value for displacement damage
- Optocouplers continue to work satisfactorily in thruster firing circuit
  - Consequence of higher circuit margin used by designers

### Failure of Power Converters Due to Optocoupler Degradation



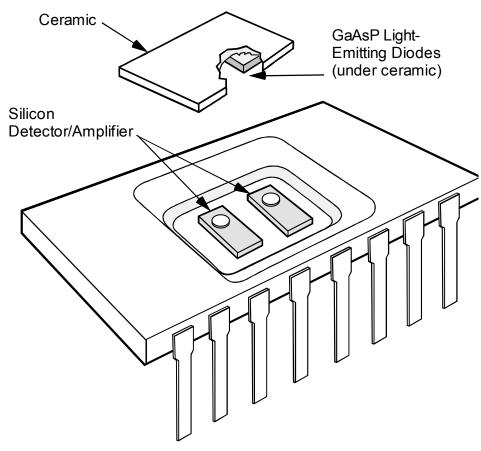
## **Optocoupler Transients**

## Voltage System Shutdown Occurred on Hubble Space Telescope

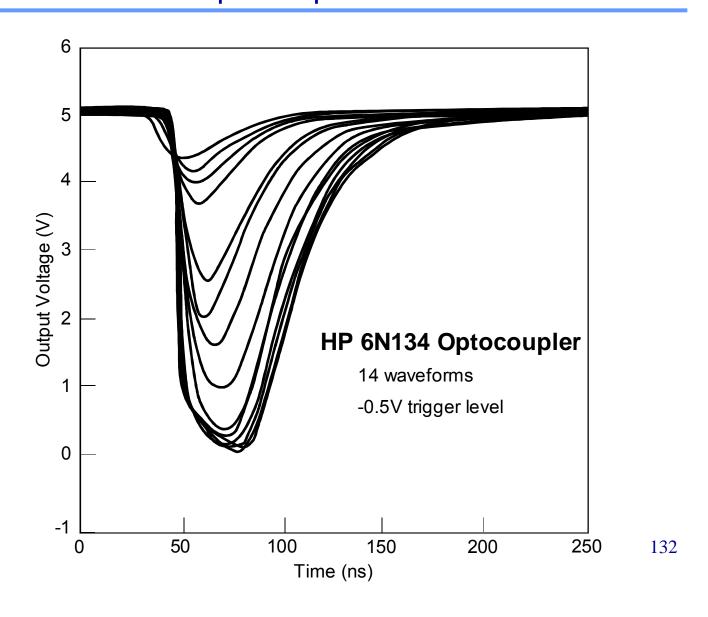
- Observed after upgraded electronics were installed
- Strongly correlated with orbit pattern

#### Laboratory Tests Showed that Shutdown Was Caused by Transients from Protons

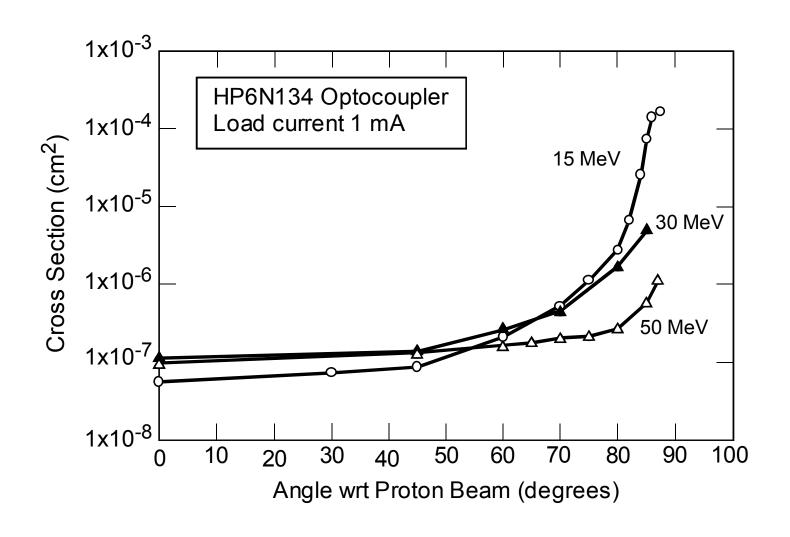
- Dominated by charge in photodetector
- Heavy ions also produce transients



## Example of Transients from Protons for 6N134 Optocoupler



## Angular Dependence of Proton Upset Cross Section



## **Course Summary**

## **Environments and System Requirements**

#### JPL Systems Have a Variety of Mission Requirements

- Short duration missions with low radiation levels
- Interplanetary missions with extremely high levels
- Earth-orbiting missions where proton effects dominate

#### Overall Mission Requirements Must Be Understood

- "Reflexive" policies and procedures should be avoided
- Testing is not always required

Using Parts Where Radiation Data Exists Can Be Cost Effective

## Single-Event Upset

#### SEE Effects Have Become Worse As Parts Have Evolved

- Device scaling
- Complex internal design and architecture
- Functional interrupt problems

#### SEE Testing Has Become More Complex

- Device complexity
- New phenomena
- Multiple-bit upset

Successful Use of Commercial Parts Depends on System Design

## Permanent Damage from Single-Particles

#### Latchup Is the Most Critical Catastrophic Damage Issue

- Many CMOS circuits are sensitive to latchup
- Difficult and costly to characterize latchup in detail
- Best alternative is to eliminate latchup-prone devices

## Gate Rupture and Burnout Effects Are Becoming More Important

- Previously only an issue for power MOSFETs
- Permanent damage has been observed in pulse-width modulators
- Testing and qualification methods need to consider these effects

#### **Total Dose Effects**

Total Dose Damage Remains a Key Issue for Many Technologies

- Field oxide failure causes huge increases and functional failure in CMOS
- Gate oxide threshold shift is important in many technologies
- Internal charge pumps are usually highly susceptible to total dose damage

Low Dose Rate Damage Effects Are a Major Issue for Bipolar Devices

- Problem not completely understood
- Wide variation among manufacturers
- JPL has an excellent facility for tests at very low dose rate

Devices with High Maximum Voltage Ratings Are Often a Problem

- Low doping levels
- Increased oxide thickness

#### Permanent Damage from Protons and Electrons

#### Permanent Damage Issues Are Often Overlooked

#### **Technologies Where Displacement Effects Matter**

- Linear integrated circuits
- Light emitting diodes
- Optical detectors
- Optocouplers

#### Cobalt-60 Gamma Rays Are a Compromise

- Cost effective
- Appropriate for technologies where displacement damage doesn't matter
- Provides no information about displacement damage effects